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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### Details

Product Status	Active
Number of LABs/CLBs	-
Number of Logic Elements/Cells	-
Total RAM Bits	36864
Number of I/O	71
Number of Gates	125000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	100-TQFP
Supplier Device Package	100-VQFP (14x14)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/a3p125-2vq100">https://www.e-xfl.com/product-detail/microchip-technology/a3p125-2vq100</a>

## ProASIC3 Device Family Overview

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## Pin Descriptions

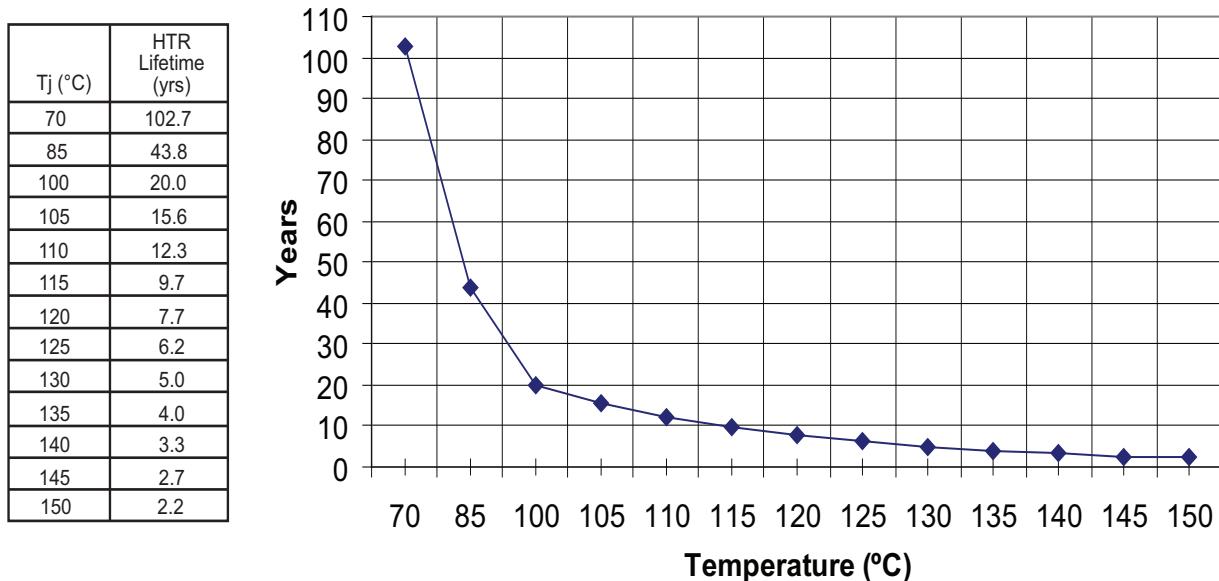
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*Note: HTR time is the period during which you would not expect a verify failure due to flash cell leakage.*

**Figure 2-1 • High-Temperature Data Retention (HTR)**

**Table 2-3 • Flash Programming Limits – Retention, Storage and Operating Temperature<sup>1</sup>**

Product Grade	Programming Cycles	Program Retention (biased/unbiased)	Maximum Storage Temperature T <sub>STG</sub> (°C)	Maximum Operating Junction Temperature T <sub>J</sub> (°C) <sup>2</sup>
Commercial	500	20 years	110	100
Industrial	500	20 years	110	100

1. This is a stress rating only; functional operation at any condition other than those indicated is not implied.

2. These limits apply for program/data retention only. Refer to Table 2-1 on page 2-1 and Table 2-2 for device operating conditions and absolute limits.

**Table 2-4 • Overshoot and Undershoot Limits<sup>1</sup>**

VCCI and VMV	Average VCCI–GND Overshoot or Undershoot Duration as a Percentage of Clock Cycle <sup>2</sup>	Maximum Overshoot/Undershoot <sup>2</sup>
2.7 V or less	10%	1.4 V
	5%	1.49 V
3 V	10%	1.1 V
	5%	1.19 V
3.3 V	10%	0.79 V
	5%	0.88 V
3.6 V	10%	0.45 V
	5%	0.54 V

**Notes:**

1. Based on reliability requirements at 85°C.
2. The duration is allowed at one out of six clock cycles. If the overshoot/undershoot occurs at one out of two cycles, the maximum overshoot/undershoot has to be reduced by 0.15 V.
3. This table does not provide PCI overshoot/undershoot limits.

**Table 2-13 • Summary of I/O Output Buffer Power (Per Pin) – Default I/O Software Settings<sup>1</sup>**  
**Applicable to Standard I/O Banks**

	C <sub>LOAD</sub> (pF)	VCCI (V)	Static Power PDC3 (mW) <sup>2</sup>	Dynamic Power PAC10 (μW/MHz) <sup>3</sup>
<b>Single-Ended</b>				
3.3 V LVTTL / 3.3 V LVCMOS	35	3.3	–	431.08
3.3 V LVCMOS Wide Range <sup>4</sup>	35	3.3	–	431.08
2.5 V LVCMOS	35	2.5	–	247.36
1.8 V LVCMOS	35	1.8	–	128.46
1.5 V LVCMOS (JESD8-11)	35	1.5	–	89.46

**Notes:**

1. Dynamic power consumption is given for standard load and software default drive strength and output slew.
2. P<sub>DC3</sub> is the static power (where applicable) measured on VCCI.
3. P<sub>AC10</sub> is the total dynamic power measured on VCC and VCCI.
4. All LVCMOS 3.3 V software macros support LVCMOS 3.3 V wide range as specified in the JESD8-B specification.

**Table 2-19 • Summary of Maximum and Minimum DC Input and Output Levels Applicable to Commercial and Industrial Conditions—Software Default Settings Applicable to Standard Plus I/O Banks**

I/O Standard	Drive Strength	Equiv. Software Default Drive Strength Option <sup>2</sup>	Slew Rate	VIL		VIH		VOL		VOH		IOL <sup>1</sup> mA	IOH <sup>1</sup> mA
				Min V	Max V	Min V	Max V	Max V	Min V	Max V	Min V		
3.3 V LVTTL / 3.3 V LVCMOS	12 mA	12 mA	High	-0.3	0.8	2	3.6	0.4	2.4	12	12		
3.3 V LVCMOS Wide Range <sup>3</sup>	100 µA	12 mA	High	-0.3	0.8	2	3.6	0.2	VCCI - 0.2	0.1	0.1		
2.5 V LVCMOS	12 mA	12 mA	High	-0.3	0.7	1.7	2.7	0.7	1.7	12	12		
1.8 V LVCMOS	8 mA	8 mA	High	-0.3	0.35 * VCCI	0.65 * VCCI	1.9	0.45	VCCI - 0.45	8	8		
1.5 V LVCMOS	4 mA	4 mA	High	-0.3	0.35 * VCCI	0.65 * VCCI	1.6	0.25 * VCCI	0.75 * VCCI	4	4		
3.3 V PCI	Per PCI specifications												
3.3 V PCI-X	Per PCI-X specifications												

**Notes:**

1. Currents are measured at 85°C junction temperature.
2. 3.3 V LVCMOS wide range is applicable to 100 µA drive strength only. The configuration will NOT operate at the equivalent software default drive strength. These values are for Normal Ranges ONLY.
3. All LVCMOS 3.3 V software macros support LVCMOS 3.3 V wide range as specified in the JESD8-B specification.

## Timing Characteristics

**Table 2-50 • 3.3 V LVTTL / 3.3 V LVCMOS High Slew**

Commercial-Case Conditions:  $T_J = 70^\circ\text{C}$ , Worst-Case VCC = 1.425 V, Worst-Case VCCI = 3.0 V  
 Applicable to Advanced I/O Banks

Drive Strength	Equiv. Software Default Drive Strength Option <sup>1</sup>	Speed Grade	$t_{DOUT}$	$t_{DP}$	$t_{DIN}$	$t_{PY}$	$t_{EOUT}$	$t_{ZL}$	$t_{ZH}$	$t_{LZ}$	$t_{HZ}$	$t_{ZLS}$	$t_{ZHS}$	Units
100 $\mu\text{A}$	4 mA	Std.	0.60	11.84	0.04	1.02	0.43	11.84	10.00	4.10	4.04	15.23	13.40	ns
		-1	0.51	10.07	0.04	0.86	0.36	10.07	8.51	3.48	3.44	12.96	11.40	ns
		-2	0.45	8.84	0.03	0.76	0.32	8.84	7.47	3.06	3.02	11.38	10.00	ns
100 $\mu\text{A}$	6 mA	Std.	0.60	7.59	0.04	1.02	0.43	7.59	6.18	4.62	4.95	10.98	9.57	ns
		-1	0.51	6.45	0.04	0.86	0.36	6.45	5.25	3.93	4.21	9.34	8.14	ns
		-2	0.45	5.67	0.03	0.76	0.32	5.67	4.61	3.45	3.70	8.20	7.15	ns
100 $\mu\text{A}$	8 mA	Std.	0.60	7.59	0.04	1.02	0.43	7.59	6.18	4.62	4.95	10.98	9.57	ns
		-1	0.51	6.45	0.04	0.86	0.36	6.45	5.25	3.93	4.21	9.34	8.14	ns
		-2	0.45	5.67	0.03	0.76	0.32	5.67	4.61	3.45	3.70	8.20	7.15	ns
100 $\mu\text{A}$	12 mA	Std.	0.60	5.46	0.04	1.02	0.43	5.46	4.29	4.97	5.54	8.86	7.68	ns
		-1	0.51	4.65	0.04	0.86	0.36	4.65	3.65	4.22	4.71	7.53	6.54	ns
		-2	0.45	4.08	0.03	0.76	0.32	4.08	3.20	3.71	4.14	6.61	5.74	ns
100 $\mu\text{A}$	16 mA	Std.	0.60	5.15	0.04	1.02	0.43	5.15	3.89	5.04	5.69	8.55	7.29	ns
		-1	0.51	4.38	0.04	0.86	0.36	4.38	3.31	4.29	4.84	7.27	6.20	ns
		-2	0.45	3.85	0.03	0.76	0.32	3.85	2.91	3.77	4.25	6.38	5.44	ns
100 $\mu\text{A}$	24 mA	Std.	0.60	4.75	0.04	1.02	0.43	4.75	3.22	5.14	6.28	8.15	6.61	ns
		-1	0.51	4.04	0.04	0.86	0.36	4.04	2.74	4.37	5.34	6.93	5.62	ns
		-2	0.45	3.55	0.03	0.76	0.32	3.55	2.40	3.84	4.69	6.09	4.94	ns

**Notes:**

1. The minimum drive strength for any LVCMOS 3.3 V software configuration when run in wide range is  $\pm 100 \mu\text{A}$ . Drive strength displayed in the software is supported for normal range only. For a detailed I/V curve, refer to the IBIS models.
2. Software default selection highlighted in gray.
3. For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

**Table 2-51 • 3.3 V LVTTL / 3.3 V LVCMOS Low Slew**

 Commercial-Case Conditions:  $T_J = 70^\circ\text{C}$ , Worst-Case VCC = 1.425 V, Worst-Case VCCI = 3.0 V  
 Applicable to Advanced I/O Banks

Drive Strength	Equiv. Software Default Drive Strength Option <sup>1</sup>	Speed Grade	$t_{DOUT}$	$t_{DP}$	$t_{DIN}$	$t_{PY}$	$t_{EOUT}$	$t_{ZL}$	$t_{ZH}$	$t_{LZ}$	$t_{HZ}$	$t_{ZLS}$	$t_{ZHS}$	Units
100 $\mu\text{A}$	2 mA	Std.	0.60	15.86	0.04	1.54	0.43	15.86	13.51	4.09	3.80	19.25	16.90	ns
		-1	0.51	13.49	0.04	1.31	0.36	13.49	11.49	3.48	3.23	16.38	14.38	ns
		-2	0.45	11.84	0.03	1.15	0.32	11.84	10.09	3.05	2.84	14.38	12.62	ns
100 $\mu\text{A}$	4 mA	Std.	0.60	11.25	0.04	1.54	0.43	11.25	9.54	4.61	4.70	14.64	12.93	ns
		-1	0.51	9.57	0.04	1.31	0.36	9.57	8.11	3.92	4.00	12.46	11.00	ns
		-2	0.45	8.40	0.03	1.15	0.32	8.40	7.12	3.44	3.51	10.93	9.66	ns
100 $\mu\text{A}$	6 mA	Std.	0.60	11.25	0.04	1.54	0.43	11.25	9.54	4.61	4.70	14.64	12.93	ns
		-1	0.51	9.57	0.04	1.31	0.36	9.57	8.11	3.92	4.00	12.46	11.00	ns
		-2	0.45	8.40	0.03	1.15	0.32	8.40	7.12	3.44	3.51	10.93	9.66	ns
100 $\mu\text{A}$	8 mA	Std.	0.60	8.63	0.04	1.54	0.43	8.63	7.39	4.96	5.28	12.02	10.79	ns
		-1	0.51	7.34	0.04	1.31	0.36	7.34	6.29	4.22	4.49	10.23	9.18	ns
		-2	0.45	6.44	0.03	1.15	0.32	6.44	5.52	3.70	3.94	8.98	8.06	ns
100 $\mu\text{A}$	16 mA	Std.	0.60	8.05	0.04	1.54	0.43	8.05	6.93	5.03	5.43	11.44	10.32	ns
		-1	0.51	6.85	0.04	1.31	0.36	6.85	5.90	4.28	4.62	9.74	8.78	ns
		-2	0.45	6.01	0.03	1.15	0.32	6.01	5.18	3.76	4.06	8.55	7.71	ns
100 $\mu\text{A}$	24 mA	Std.	0.60	7.50	0.04	1.54	0.43	7.50	6.90	5.13	6.00	10.89	10.29	ns
		-1	0.51	6.38	0.04	1.31	0.36	6.38	5.87	4.36	5.11	9.27	8.76	ns
		-2	0.45	5.60	0.03	1.15	0.32	5.60	5.15	3.83	4.48	8.13	7.69	ns

**Notes:**

1. The minimum drive strength for any LVCMOS 3.3 V software configuration when run in wide range is  $\pm 100 \mu\text{A}$ . Drive strength displayed in the software is supported for normal range only. For a detailed I/V curve, refer to the IBIS models.
2. For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

**Table 2-77 • Minimum and Maximum DC Input and Output Levels  
Applicable to Standard Plus I/O Banks**

1.5 V LVC MOS	VIL		VIH		VOL	VOH	IOL	IOH	IOSL	IOSH	IIL <sup>1</sup>	IIH <sup>2</sup>
Drive Strength	Min. V	Max. V	Min. V	Max. V	Max. V	Min. V	mA	mA	Max. mA <sup>3</sup>	Max. mA <sup>3</sup>	µA <sup>4</sup>	µA <sup>4</sup>
2 mA	-0.3	0.35 * VCCI	0.65 * VCCI	1.575	0.25 * VCCI	0.75 * VCCI	2	2	16	13	10	10
4 mA	-0.3	0.35 * VCCI	0.65 * VCCI	1.575	0.25 * VCCI	0.75 * VCCI	4	4	33	25	10	10

**Notes:**

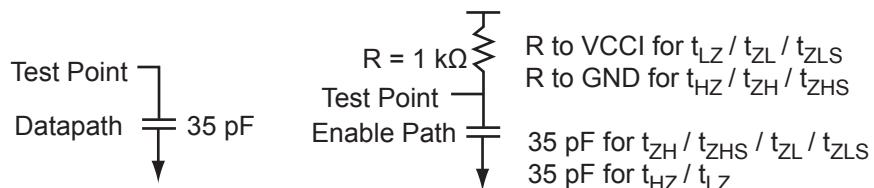
1. *IIL* is the input leakage current per I/O pin over recommended operation conditions where  $-0.3 \text{ V} < \text{VIN} < \text{VIL}$ .
2. *IIH* is the input leakage current per I/O pin over recommended operating conditions  $\text{VIH} < \text{VIN} < \text{VCCI}$ . Input current is larger when operating outside recommended ranges
3. Currents are measured at high temperature ( $100^\circ\text{C}$  junction temperature) and maximum voltage.
4. Currents are measured at  $85^\circ\text{C}$  junction temperature.
5. Software default selection highlighted in gray.

**Table 2-78 • Minimum and Maximum DC Input and Output Levels  
Applicable to Standard I/O Banks**

1.5 V LVC MOS	VIL		VIH		VOL	VOH	IOL	IOH	IOSL	IOSH	IIL <sup>1</sup>	IIH <sup>2</sup>
Drive Strength	Min. V	Max. V	Min. V	Max. V	Max. V	Min. V	mA	mA	Max. mA <sup>3</sup>	Max. mA <sup>3</sup>	µA <sup>4</sup>	µA <sup>4</sup>
2 mA	-0.3	0.35 * VCCI	0.65 * VCCI	3.6	0.25 * VCCI	0.75 * VCCI	2	2	13	16	10	10

**Notes:**

1. *IIL* is the input leakage current per I/O pin over recommended operation conditions where  $-0.3 \text{ V} < \text{VIN} < \text{VIL}$ .
2. *IIH* is the input leakage current per I/O pin over recommended operating conditions  $\text{VIH} < \text{VIN} < \text{VCCI}$ . Input current is larger when operating outside recommended ranges.
3. Currents are measured at high temperature ( $100^\circ\text{C}$  junction temperature) and maximum voltage.
4. Currents are measured at  $85^\circ\text{C}$  junction temperature.
5. Software default selection highlighted in gray.



**Figure 2-10 • AC Loading**

**Table 2-79 • AC Waveforms, Measuring Points, and Capacitive Loads**

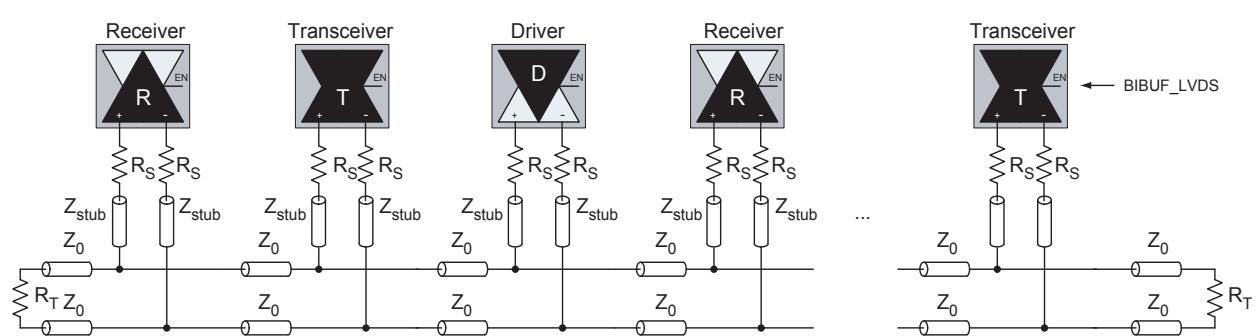
Input Low (V)	Input High (V)	Measuring Point* (V)	C <sub>LOAD</sub> (pF)
0	1.5	0.75	35

Note: \*Measuring point =  $V_{trip}$ . See Table 2-22 on page 2-22 for a complete table of trip points.

## B-LVDS/M-LVDS

Bus LVDS (B-LVDS) and Multipoint LVDS (M-LVDS) specifications extend the existing LVDS standard to high-performance multipoint bus applications. Multidrop and multipoint bus configurations may contain any combination of drivers, receivers, and transceivers. Microsemi LVDS drivers provide the higher drive current required by B-LVDS and M-LVDS to accommodate the loading. The drivers require series terminations for better signal quality and to control voltage swing. Termination is also required at both ends of the bus since the driver can be located anywhere on the bus. These configurations can be implemented using the TRIBUF\_LVDS and BIBUF\_LVDS macros along with appropriate terminations. Multipoint designs using Microsemi LVDS macros can achieve up to 200 MHz with a maximum of 20 loads. A sample application is given in [Figure 2-13](#). The input and output buffer delays are available in the LVDS section in [Table 2-92](#).

Example: For a bus consisting of 20 equidistant loads, the following terminations provide the required differential voltage, in worst-case Industrial operating conditions, at the farthest receiver:  $R_S = 60 \Omega$  and  $R_T = 70 \Omega$ , given  $Z_0 = 50 \Omega$  (2") and  $Z_{\text{stub}} = 50 \Omega$  (~1.5").

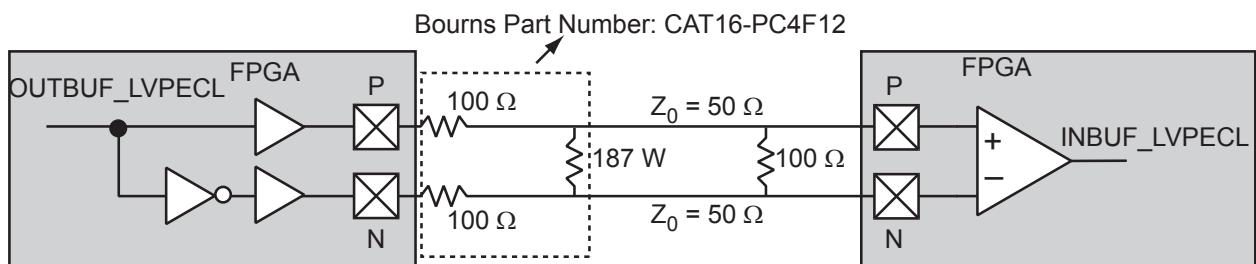


**Figure 2-13 • B-LVDS/M-LVDS Multipoint Application Using LVDS I/O Buffers**

## LVPECL

Low-Voltage Positive Emitter-Coupled Logic (LVPECL) is another differential I/O standard. It requires that one data bit be carried through two signal lines. Like LVDS, two pins are needed. It also requires external resistor termination.

The full implementation of the LVPECL transmitter and receiver is shown in an example in [Figure 2-14](#). The building blocks of the LVPECL transmitter-receiver are one transmitter macro, one receiver macro, three board resistors at the transmitter end, and one resistor at the receiver end. The values for the three driver resistors are different from those used in the LVDS implementation because the output standard specifications are different.



**Figure 2-14 • LVPECL Circuit Diagram and Board-Level Implementation**

## I/O Register Specifications

### Fully Registered I/O Buffers with Synchronous Enable and Asynchronous Preset

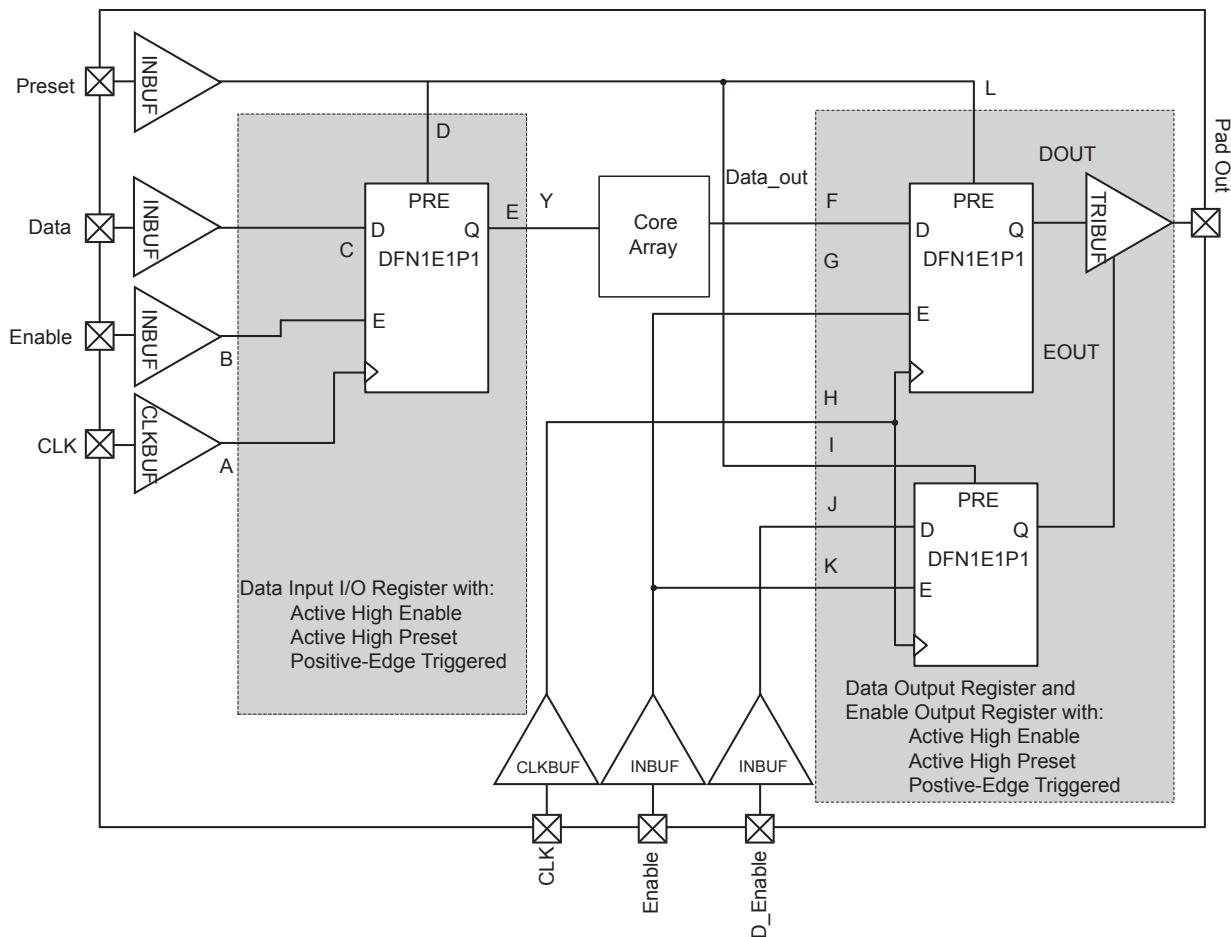


Figure 2-15 • Timing Model of Registered I/O Buffers with Synchronous Enable and Asynchronous Preset

**Table 2-97 • Parameter Definition and Measuring Nodes**

Parameter Name	Parameter Definition	Measuring Nodes (from, to)*
$t_{OCLKQ}$	Clock-to-Q of the Output Data Register	HH, DOUT
$t_{OSUD}$	Data Setup Time for the Output Data Register	FF, HH
$t_{OHD}$	Data Hold Time for the Output Data Register	FF, HH
$t_{OSUE}$	Enable Setup Time for the Output Data Register	GG, HH
$t_{OHE}$	Enable Hold Time for the Output Data Register	GG, HH
$t_{OCLR2Q}$	Asynchronous Clear-to-Q of the Output Data Register	LL, DOUT
$t_{OREMCLR}$	Asynchronous Clear Removal Time for the Output Data Register	LL, HH
$t_{ORECCLR}$	Asynchronous Clear Recovery Time for the Output Data Register	LL, HH
$t_{OECLKQ}$	Clock-to-Q of the Output Enable Register	HH, EOUT
$t_{OESUD}$	Data Setup Time for the Output Enable Register	JJ, HH
$t_{OEHD}$	Data Hold Time for the Output Enable Register	JJ, HH
$t_{OESUE}$	Enable Setup Time for the Output Enable Register	KK, HH
$t_{OEHE}$	Enable Hold Time for the Output Enable Register	KK, HH
$t_{OECLR2Q}$	Asynchronous Clear-to-Q of the Output Enable Register	II, EOUT
$t_{OEREMCLR}$	Asynchronous Clear Removal Time for the Output Enable Register	II, HH
$t_{OERECCCLR}$	Asynchronous Clear Recovery Time for the Output Enable Register	II, HH
$t_{ICLKQ}$	Clock-to-Q of the Input Data Register	AA, EE
$t_{ISUD}$	Data Setup Time for the Input Data Register	CC, AA
$t_{IHD}$	Data Hold Time for the Input Data Register	CC, AA
$t_{ISUE}$	Enable Setup Time for the Input Data Register	BB, AA
$t_{IHE}$	Enable Hold Time for the Input Data Register	BB, AA
$t_{ICLR2Q}$	Asynchronous Clear-to-Q of the Input Data Register	DD, EE
$t_{IREMCLR}$	Asynchronous Clear Removal Time for the Input Data Register	DD, AA
$t_{IRECCLR}$	Asynchronous Clear Recovery Time for the Input Data Register	DD, AA

Note: \*See [Figure 2-16 on page 2-71](#) for more information.

## VersaTile Characteristics

### VersaTile Specifications as a Combinatorial Module

The ProASIC3 library offers all combinations of LUT-3 combinatorial functions. In this section, timing characteristics are presented for a sample of the library. For more details, refer to the [Fusion, IGLOO®/e, and ProASIC3/E Macro Library Guide](#).

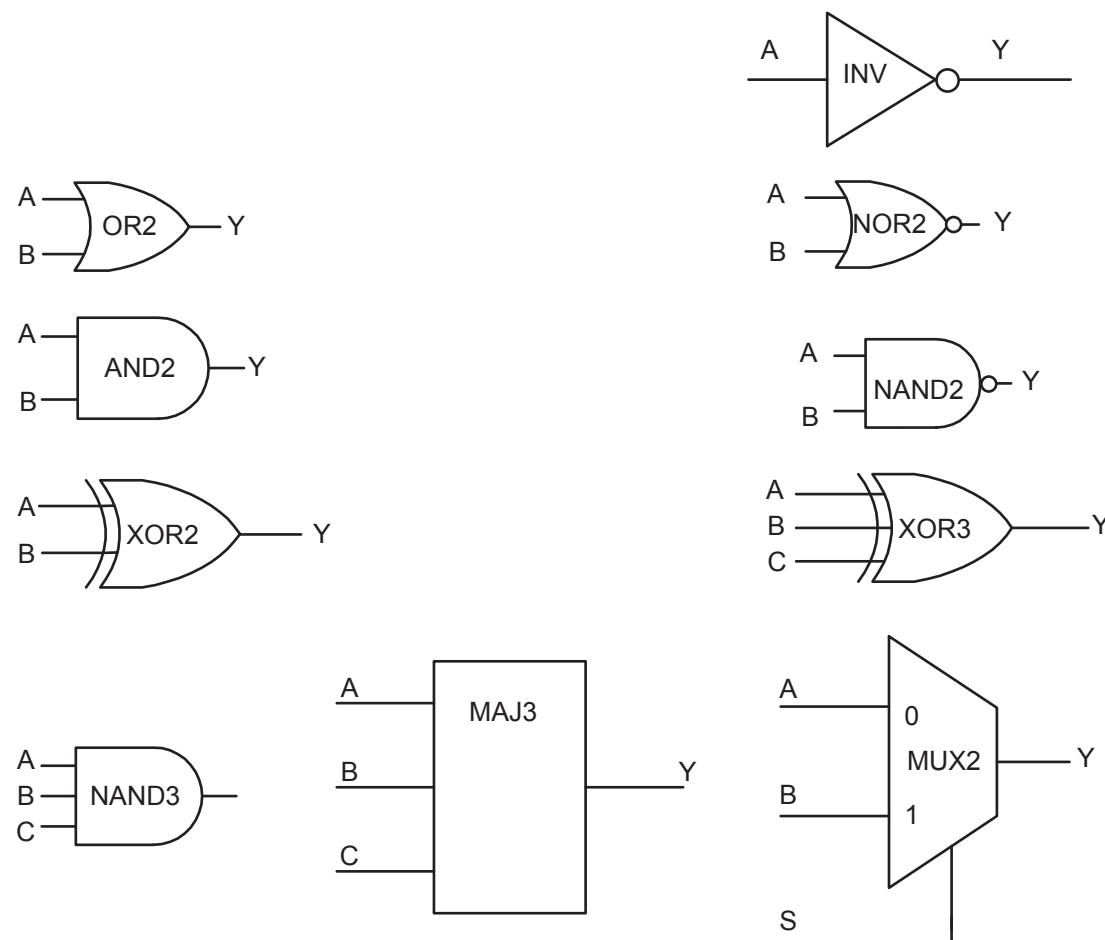


Figure 2-24 • Sample of Combinatorial Cells

## Timing Waveforms

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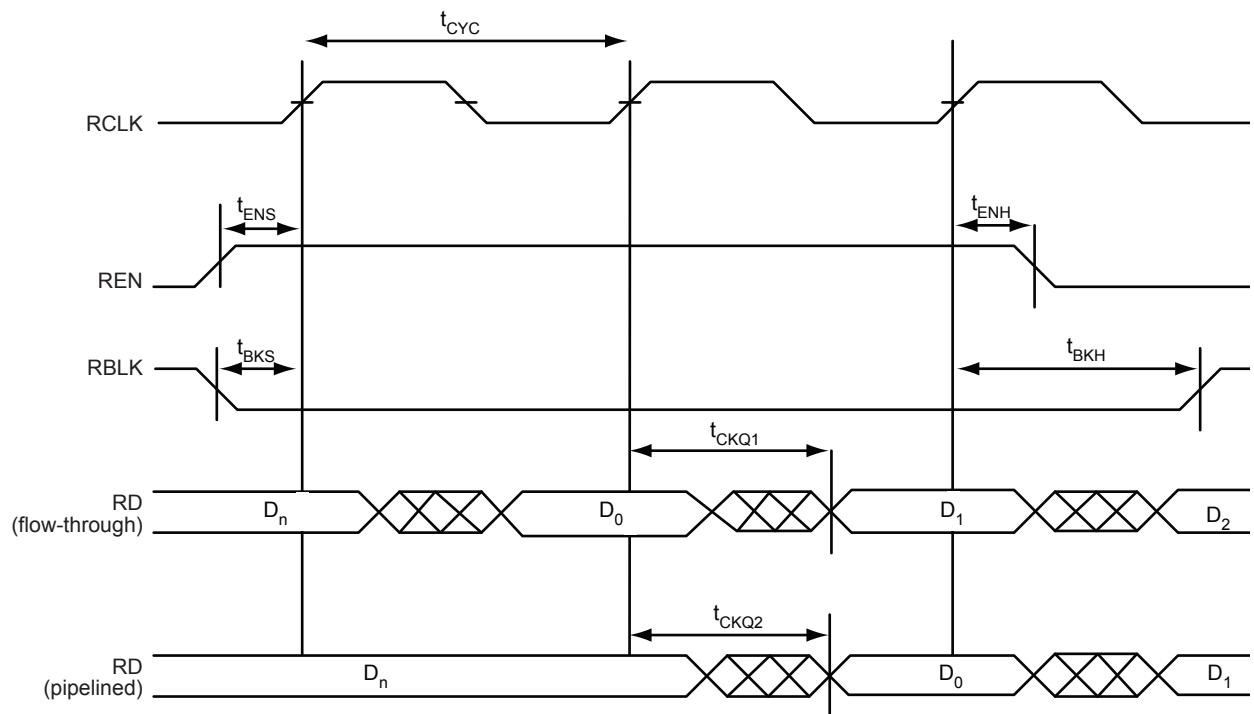


Figure 2-37 • FIFO Read

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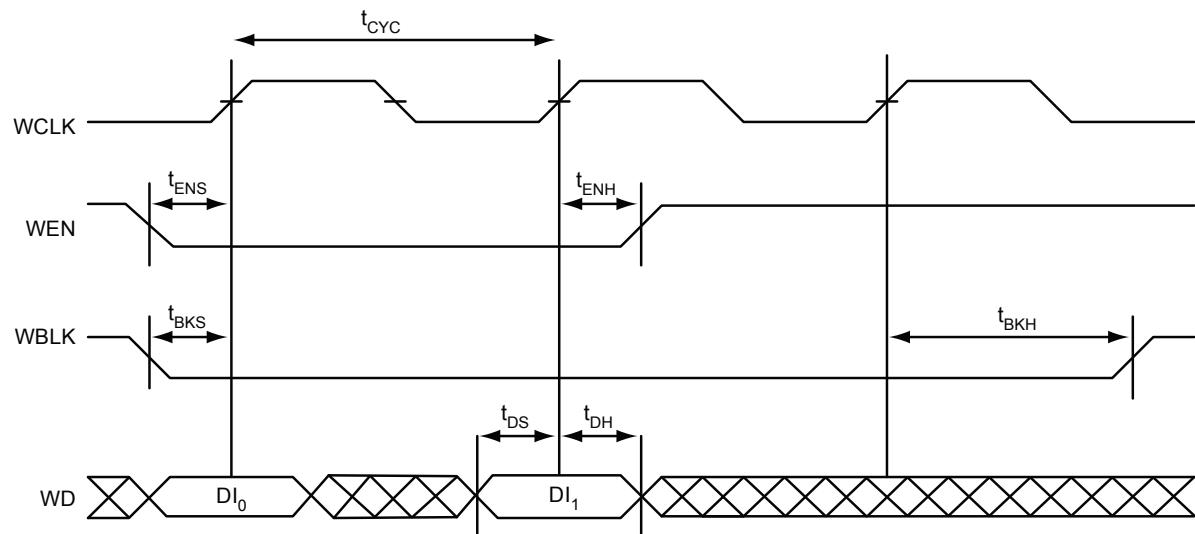
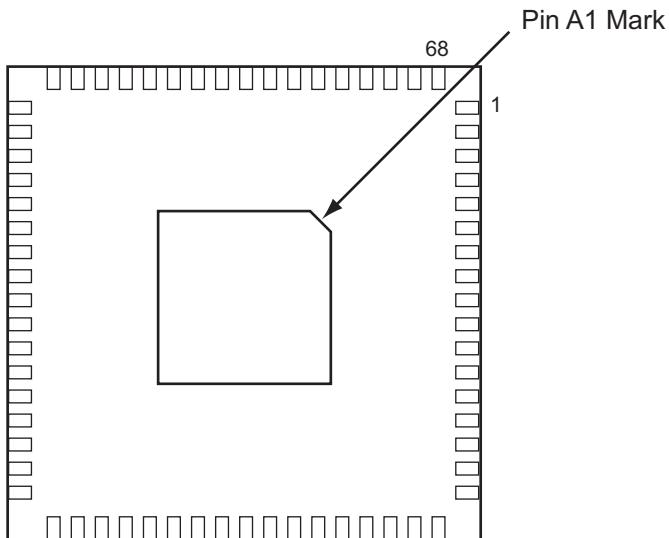


Figure 2-38 • FIFO Write

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## QN68 – Bottom View

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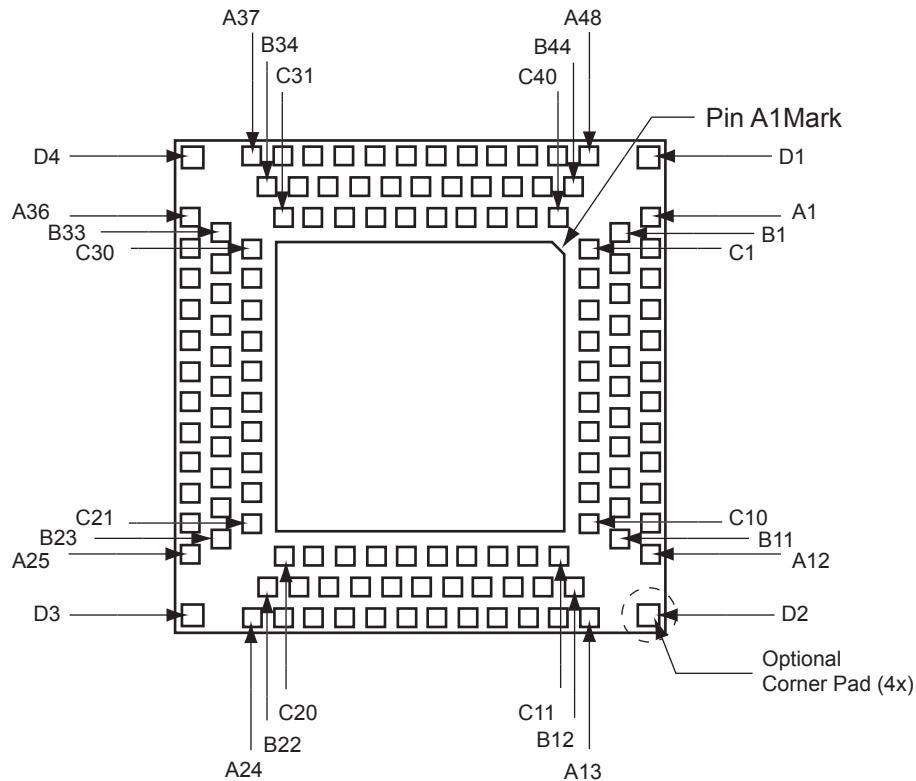
**Note:** *The die attach paddle center of the package is tied to ground (GND).*

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### Note

For more information on package drawings, see [PD3068: Package Mechanical Drawings](#).

## QN132 – Bottom View



**Notes:**

1. The die attach paddle center of the package is tied to ground (GND).
2. Option corner pads come with this device and package combination. It is optional to tie them to ground or leave them floating.
3. The QN132 package is discontinued and is not available for ProASIC3 devices.
4. For more information on package drawings, see [PD3068: Package Mechanical Drawings](#).

<b>PQ208</b>	
<b>Pin Number</b>	<b>A3P125 Function</b>
1	GND
2	GAA2/IO67RSB1
3	IO68RSB1
4	GAB2/IO69RSB1
5	IO132RSB1
6	GAC2/IO131RSB1
7	NC
8	NC
9	IO130RSB1
10	IO129RSB1
11	NC
12	IO128RSB1
13	NC
14	NC
15	NC
16	VCC
17	GND
18	VCCIB1
19	IO127RSB1
20	NC
21	GFC1/IO126RSB1
22	GFC0/IO125RSB1
23	GFB1/IO124RSB1
24	GFB0/IO123RSB1
25	VCOMPLF
26	GFA0/IO122RSB1
27	VCCPLF
28	GFA1/IO121RSB1
29	GND
30	GFA2/IO120RSB1
31	NC
32	GFB2/IO119RSB1
33	NC
34	GFC2/IO118RSB1
35	IO117RSB1
36	NC

<b>PQ208</b>	
<b>Pin Number</b>	<b>A3P125 Function</b>
37	IO116RSB1
38	IO115RSB1
39	NC
40	VCCIB1
41	GND
42	IO114RSB1
43	IO113RSB1
44	GEC1/IO112RSB1
45	GEC0/IO111RSB1
46	GEB1/IO110RSB1
47	GEB0/IO109RSB1
48	GEA1/IO108RSB1
49	GEA0/IO107RSB1
50	VMV1
51	GNDQ
52	GND
53	NC
54	NC
55	GEA2/IO106RSB1
56	GEB2/IO105RSB1
57	GEC2/IO104RSB1
58	IO103RSB1
59	IO102RSB1
60	IO101RSB1
61	IO100RSB1
62	VCCIB1
63	IO99RSB1
64	IO98RSB1
65	GND
66	IO97RSB1
67	IO96RSB1
68	IO95RSB1
69	IO94RSB1
70	IO93RSB1
71	VCC
72	VCCIB1

<b>PQ208</b>	
<b>Pin Number</b>	<b>A3P125 Function</b>
73	IO92RSB1
74	IO91RSB1
75	IO90RSB1
76	IO89RSB1
77	IO88RSB1
78	IO87RSB1
79	IO86RSB1
80	IO85RSB1
81	GND
82	IO84RSB1
83	IO83RSB1
84	IO82RSB1
85	IO81RSB1
86	IO80RSB1
87	IO79RSB1
88	VCC
89	VCCIB1
90	IO78RSB1
91	IO77RSB1
92	IO76RSB1
93	IO75RSB1
94	IO74RSB1
95	IO73RSB1
96	GDC2/IO72RSB1
97	GND
98	GDB2/IO71RSB1
99	GDA2/IO70RSB1
100	GNDQ
101	TCK
102	TDI
103	TMS
104	VMV1
105	GND
106	VPUMP
107	NC
108	TDO

<b>FG256</b>	
<b>Pin Number</b>	<b>A3P250 Function</b>
G13	GCC1/IO48PPB1
G14	IO47NPB1
G15	IO54PDB1
G16	IO54NDB1
H1	GFB0/IO109NPB3
H2	GFA0/IO108NDB3
H3	GFB1/IO109PPB3
H4	VCOMPLF
H5	GFC0/IO110NPB3
H6	VCC
H7	GND
H8	GND
H9	GND
H10	GND
H11	VCC
H12	GCC0/IO48NPB1
H13	GCB1/IO49PPB1
H14	GCA0/IO50NPB1
H15	NC
H16	GCB0/IO49NPB1
J1	GFA2/IO107PPB3
J2	GFA1/IO108PDB3
J3	VCCPLF
J4	IO106NDB3
J5	GFB2/IO106PDB3
J6	VCC
J7	GND
J8	GND
J9	GND
J10	GND
J11	VCC
J12	GCB2/IO52PPB1
J13	GCA1/IO50PPB1
J14	GCC2/IO53PPB1
J15	NC
J16	GCA2/IO51PDB1

<b>FG256</b>	
<b>Pin Number</b>	<b>A3P250 Function</b>
K1	GFC2/IO105PDB3
K2	IO107NPB3
K3	IO104PPB3
K4	NC
K5	VCCIB3
K6	VCC
K7	GND
K8	GND
K9	GND
K10	GND
K11	VCC
K12	VCCIB1
K13	IO52NPB1
K14	IO55RSB1
K15	IO53NPB1
K16	IO51NDB1
L1	IO105NDB3
L2	IO104NPB3
L3	NC
L4	IO102RSB3
L5	VCCIB3
L6	GND
L7	VCC
L8	VCC
L9	VCC
L10	VCC
L11	GND
L12	VCCIB1
L13	GDB0/IO59VPB1
L14	IO57VDB1
L15	IO57UDB1
L16	IO56PDB1
M1	IO103PDB3
M2	NC
M3	IO101NPB3
M4	GEC0/IO100NPB3

<b>FG256</b>	
<b>Pin Number</b>	<b>A3P250 Function</b>
M5	VMV3
M6	VCCIB2
M7	VCCIB2
M8	NC
M9	IO74RSB2
M10	VCCIB2
M11	VCCIB2
M12	VMV2
M13	NC
M14	GDB1/IO59UPB1
M15	GDC1/IO58UDB1
M16	IO56NDB1
N1	IO103NDB3
N2	IO101PPB3
N3	GEC1/IO100PPB3
N4	NC
N5	GNDQ
N6	GEA2/IO97RSB2
N7	IO86RSB2
N8	IO82RSB2
N9	IO75RSB2
N10	IO69RSB2
N11	IO64RSB2
N12	GNDQ
N13	NC
N14	VJTAG
N15	GDC0/IO58VDB1
N16	GDA1/IO60UDB1
P1	GEB1/IO99PDB3
P2	GEB0/IO99NDB3
P3	NC
P4	NC
P5	IO92RSB2
P6	IO89RSB2
P7	IO85RSB2
P8	IO81RSB2

<b>FG256</b>	
<b>Pin Number</b>	<b>A3P400 Function</b>
P9	IO98RSB2
P10	IO95RSB2
P11	IO88RSB2
P12	IO84RSB2
P13	TCK
P14	VPUMP
P15	TRST
P16	GDA0/IO79VDB1
R1	GEA1/IO135PDB3
R2	GEA0/IO135NDB3
R3	IO127RSB2
R4	GEC2/IO132RSB2
R5	IO123RSB2
R6	IO118RSB2
R7	IO112RSB2
R8	IO106RSB2
R9	IO100RSB2
R10	IO96RSB2
R11	IO89RSB2
R12	IO85RSB2
R13	GDB2/IO81RSB2
R14	TDI
R15	NC
R16	TDO
T1	GND
T2	IO126RSB2
T3	GEB2/IO133RSB2
T4	IO124RSB2
T5	IO116RSB2
T6	IO113RSB2
T7	IO107RSB2
T8	IO105RSB2
T9	IO102RSB2
T10	IO97RSB2
T11	IO92RSB2
T12	GDC2/IO82RSB2

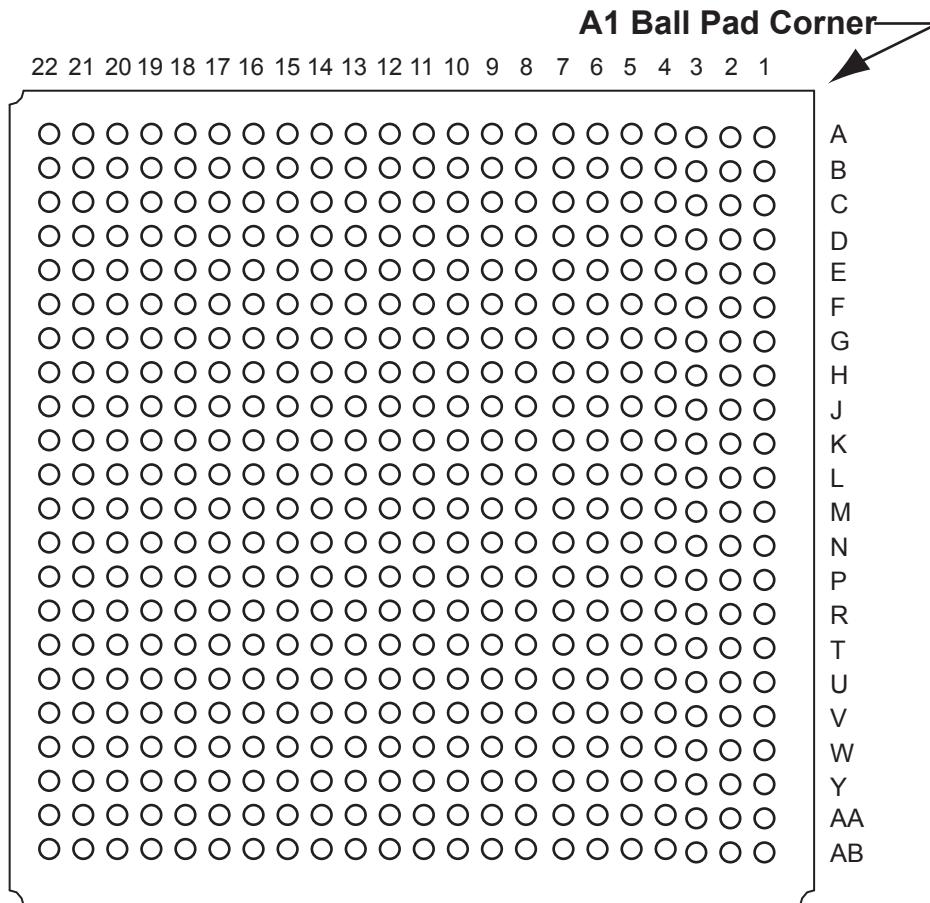
<b>FG256</b>	
<b>Pin Number</b>	<b>A3P400 Function</b>
T13	IO86RSB2
T14	GDA2/IO80RSB2
T15	TMS
T16	GND

<b>FG256</b>	
<b>Pin Number</b>	<b>A3P600 Function</b>
P9	IO107RSB2
P10	IO104RSB2
P11	IO97RSB2
P12	VMV1
P13	TCK
P14	VPUMP
P15	TRST
P16	GDA0/IO88NDB1
R1	GEA1/IO144PDB3
R2	GEA0/IO144NDB3
R3	IO139RSB2
R4	GEC2/IO141RSB2
R5	IO132RSB2
R6	IO127RSB2
R7	IO121RSB2
R8	IO114RSB2
R9	IO109RSB2
R10	IO105RSB2
R11	IO98RSB2
R12	IO96RSB2
R13	GDB2/IO90RSB2
R14	TDI
R15	GNDQ
R16	TDO
T1	GND
T2	IO137RSB2
T3	GEB2/IO142RSB2
T4	IO134RSB2
T5	IO125RSB2
T6	IO123RSB2
T7	IO118RSB2
T8	IO115RSB2
T9	IO111RSB2
T10	IO106RSB2
T11	IO102RSB2
T12	GDC2/IO91RSB2

<b>FG256</b>	
<b>Pin Number</b>	<b>A3P600 Function</b>
T13	IO93RSB2
T14	GDA2/IO89RSB2
T15	TMS
T16	GND

## FG484 – Bottom View

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### Note

For more information on package drawings, see [PD3068: Package Mechanical Drawings](#).

<b>FG484</b>	
<b>Pin Number</b>	<b>A3P400 Function</b>
Y15	VCC
Y16	NC
Y17	NC
Y18	GND
Y19	NC
Y20	NC
Y21	NC
Y22	VCCIB1
AA1	GND
AA2	VCCIB3
AA3	NC
AA4	NC
AA5	NC
AA6	NC
AA7	NC
AA8	NC
AA9	NC
AA10	NC
AA11	NC
AA12	NC
AA13	NC
AA14	NC
AA15	NC
AA16	NC
AA17	NC
AA18	NC
AA19	NC
AA20	NC
AA21	VCCIB1
AA22	GND
AB1	GND
AB2	GND
AB3	VCCIB2
AB4	NC
AB5	NC
AB6	IO121RSB2

<b>FG484</b>	
<b>Pin Number</b>	<b>A3P400 Function</b>
AB7	IO119RSB2
AB8	IO114RSB2
AB9	IO109RSB2
AB10	NC
AB11	NC
AB12	IO104RSB2
AB13	IO103RSB2
AB14	NC
AB15	NC
AB16	IO91RSB2
AB17	IO90RSB2
AB18	NC
AB19	NC
AB20	VCCIB2
AB21	GND
AB22	GND